IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

MS Patent Application Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Re:

Inventor: Judon Tony PAN

Title: BOND PAD TECHNIQUES FOR INTEGRATED CIRCUITS

Transmitted herewith is the patent application identified above, including:

- X Specification, claims and abstract, totaling 39 pages.
- X Drawings totaling 13 pages, _ Formal X Informal.
- X Executed Declaration and Power of Attorney.
- X Assignment of the invention to **Applied Materials, Inc.**
- X Assignment Recordation Cover Sheet

Fee Items	Claims Filed	Included With Basic Fee	Extra Claims	Fee Rate	Total
Total Claims	40	- 20 =	20	X \$18.00	\$360.00
Independent Claims	11	- 3 =	8	X \$84.00	\$672.00
Basic Filing Fee \$750.00					\$750.00

XX The Commissioner is hereby authorized to charge \$1,782.00 to Deposit Account No. 50-1074.

The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account No. 50-1074. A duplicate copy of this transmittal is enclosed.

XX Please address all future correspondence to:

PATENT COUNSEL APPLIED MATERIALS, INC. Legal Affairs Department P.O.BOX 450A Santa Clara, CA. 95052

I hereby certify that this correspondence is being deposited with the United States Postal Service as express mail in an envelope addressed to: MS Patent Application, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Express Mail Receipt No. EV341110216 US

Date of Deposit <u>SEPT. 2, 20</u>03

Signature Zumal o

Respectfully submitted,

Robert W. Mulcahy

Registration No. 25,436